

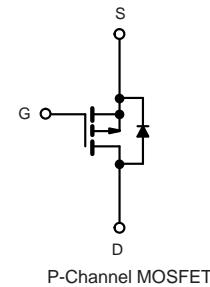
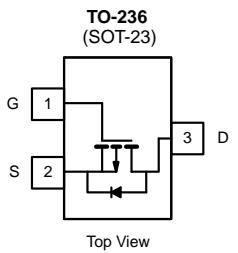
SQ2389ES-T1_GE3-VB

SQ2389ES-T1_GE3-VB Datasheet P-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY	
V _{DS} (V)	- 40
R _{DS(on)} (Ω) at V _{GS} = - 10 V	0.071
R _{DS(on)} (Ω) at V _{GS} = - 4.5 V	0.100
I _D (A)	- 3.6
Configuration	Single

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC



ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)			
PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V _{DS}	- 40	V
Gate-Source Voltage	V _{GS}	± 20	
Continuous Drain Current	I _D	- 3.6	
T _C = 125 °C		- 2.6	
Continuous Source Current (Diode Conduction)	I _S	- 3.6	A
Pulsed Drain Current ^a	I _{DM}	- 18	
Single Pulse Avalanche Current	I _{AS}	- 12	
Single Pulse Avalanche Energy	E _{AS}	7.2	mJ
Maximum Power Dissipation ^a	P _D	3	W
T _C = 125 °C		1	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to + 175	°C

THERMAL RESISTANCE RATINGS			
PARAMETER	SYMBOL	LIMIT	UNIT
Junction-to-Ambient	R _{thJA}	166	°C/W
Junction-to-Foot (Drain)		50	

Notes

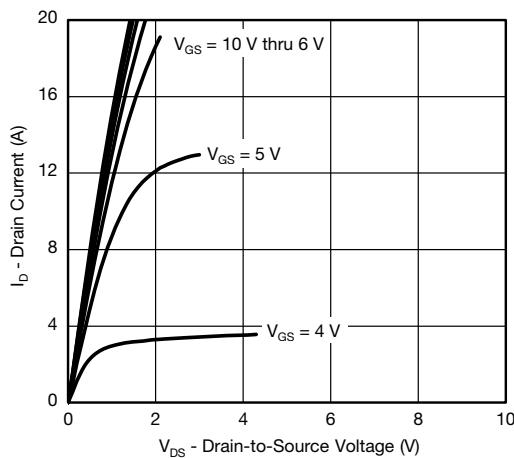
- Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %.
- When mounted on 1" square PCB (FR-4 material).
- Parametric verification ongoing.

SPECIFICATIONS ($T_C = 25^\circ\text{C}$, unless otherwise noted)								
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0$, $I_D = -250 \mu\text{A}$		- 40	-	-	V	
Gate-Source Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}$, $I_D = -250 \mu\text{A}$		- 1.0	-	- 2.5		
Gate-Source Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}$, $V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{GS} = 0 \text{ V}$	$V_{DS} = -40 \text{ V}$	-	-	- 1	μA	
		$V_{GS} = 0 \text{ V}$	$V_{DS} = -40 \text{ V}$, $T_J = 125^\circ\text{C}$	-	-	- 50		
		$V_{GS} = 0 \text{ V}$	$V_{DS} = -40 \text{ V}$, $T_J = 175^\circ\text{C}$	-	-	- 150		
On-State Drain Current ^a	$I_{D(\text{on})}$	$V_{GS} = -10 \text{ V}$	$V_{DS} \leq -5 \text{ V}$	- 10	-	-	A	
Drain-Source On-State Resistance ^a	$R_{DS(\text{on})}$	$V_{GS} = -10 \text{ V}$	$I_D = -3 \text{ A}$	-	0.071	-	Ω	
		$V_{GS} = -10 \text{ V}$	$I_D = -3 \text{ A}$, $T_J = 125^\circ\text{C}$	-	0.116	-		
		$V_{GS} = -10 \text{ V}$	$I_D = -3 \text{ A}$, $T_J = 175^\circ\text{C}$	-	0.139	-		
		$V_{GS} = -4.5 \text{ V}$	$I_D = -2.4 \text{ A}$	-	0.100	-		
Forward Transconductance ^b	g_{fs}	$V_{DS} = -5 \text{ V}$, $I_D = -3 \text{ A}$		-	8	-	S	
Dynamic^b								
Input Capacitance	C_{iss}	$V_{GS} = 0 \text{ V}$	$V_{DS} = -25 \text{ V}$, $f = 1 \text{ MHz}$	-	493	620	pF	
Output Capacitance	C_{oss}			-	76	95		
Reverse Transfer Capacitance	C_{rss}			-	51	65		
Total Gate Charge ^c	Q_g	$V_{GS} = -10 \text{ V}$	$V_{DS} = -20 \text{ V}$, $I_D = -3 \text{ A}$	-	10.5	16	nC	
Gate-Source Charge ^c	Q_{gs}			-	1.8	-		
Gate-Drain Charge ^c	Q_{gd}			-	2.6	-		
Gate Resistance	R_g	$f = 1 \text{ MHz}$		5	10	15	Ω	
Turn-On Delay Time ^c	$t_{d(\text{on})}$	$V_{DD} = -20 \text{ V}$, $R_L = 6.7 \Omega$ $I_D \equiv -3 \text{ A}$, $V_{GEN} = -10 \text{ V}$, $R_g = 1 \Omega$		-	5	8	ns	
Rise Time ^c	t_r			-	11	17		
Turn-Off Delay Time ^c	$t_{d(\text{off})}$			-	19	29		
Fall Time ^c	t_f			-	8	12		
Source-Drain Diode Ratings and Characteristics^b								
Pulsed Current ^a	I_{SM}			-	-	- 18	A	
Forward Voltage	V_{SD}	$I_F = -1.5 \text{ A}$, $V_{GS} = 0$		-	- 0.8	- 1.2	V	

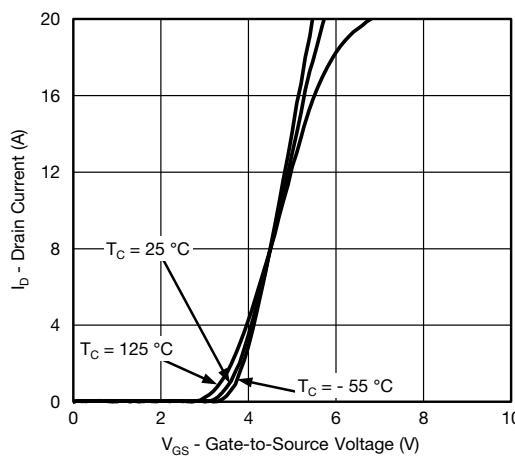
Notes

- a. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

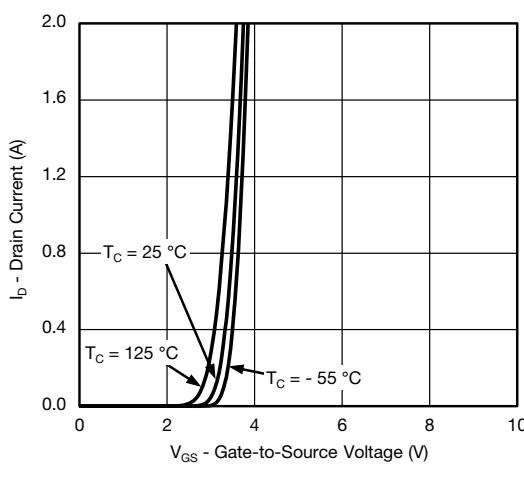
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise noted)

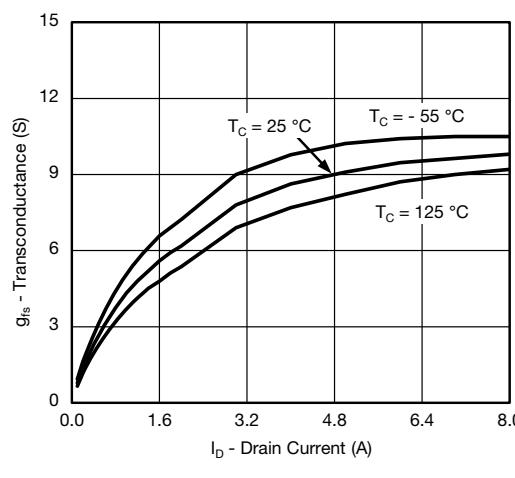
Output Characteristics



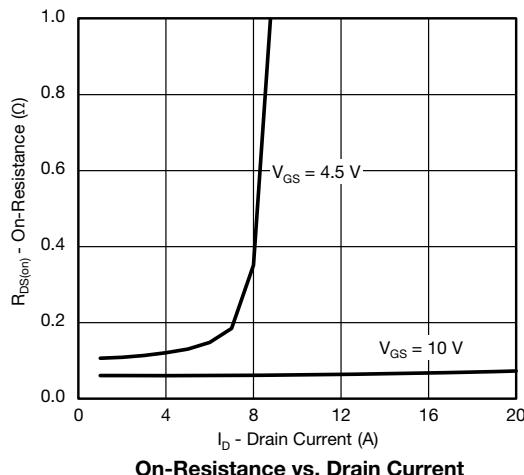
Transfer Characteristics



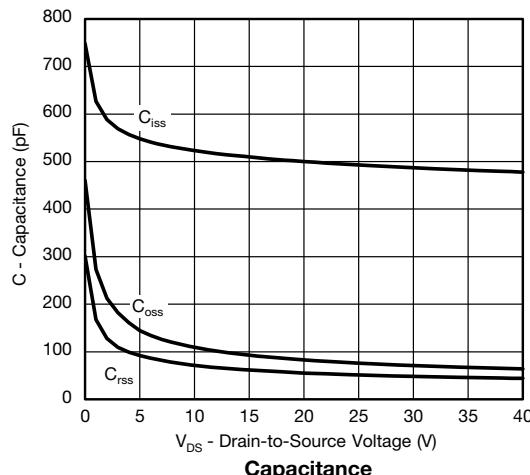
Transfer Characteristics



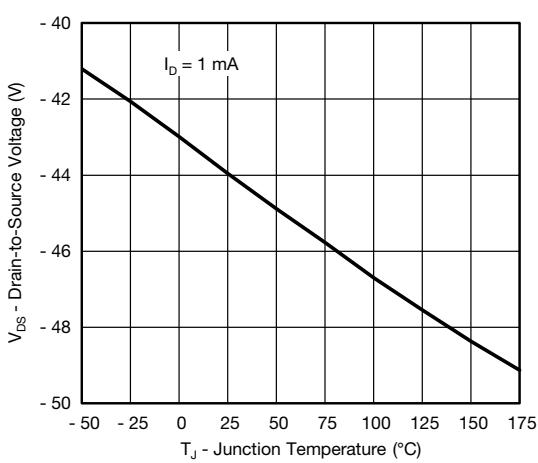
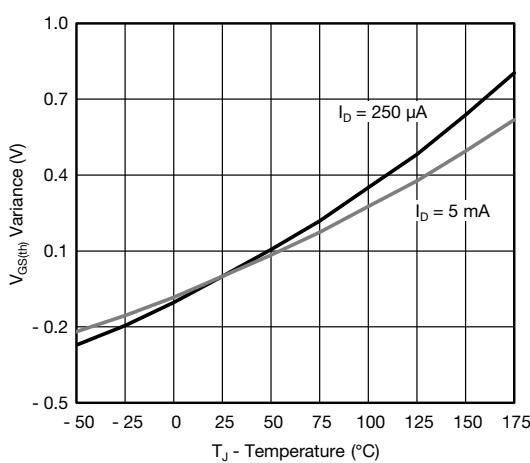
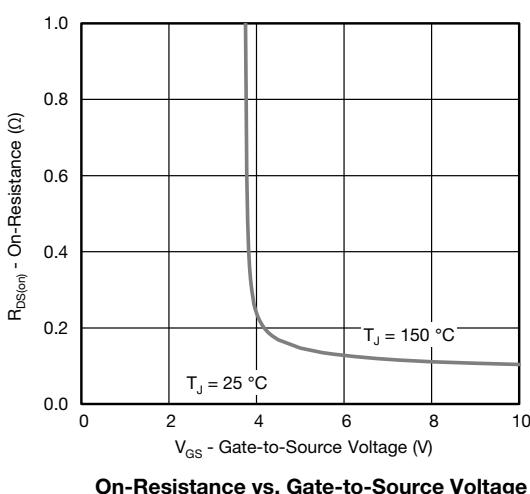
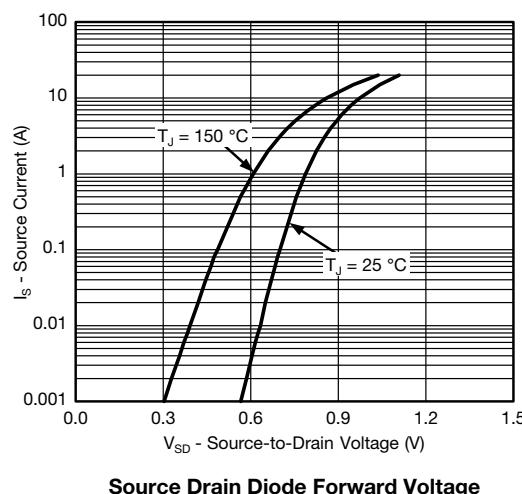
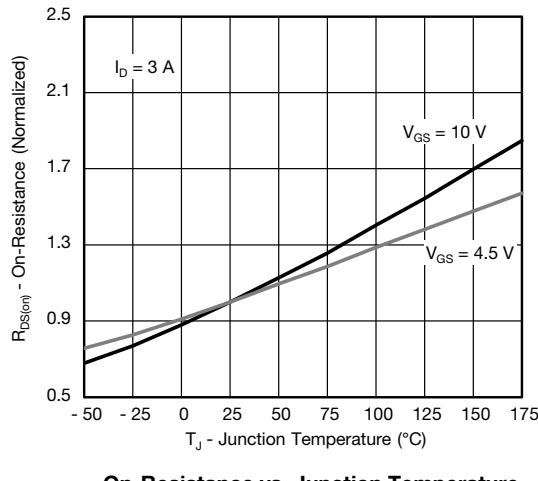
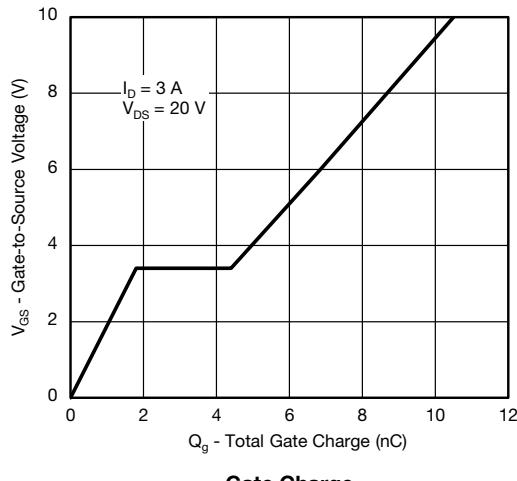
Transconductance

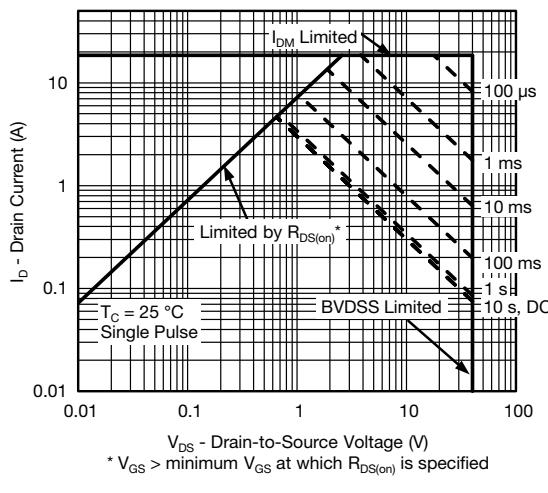
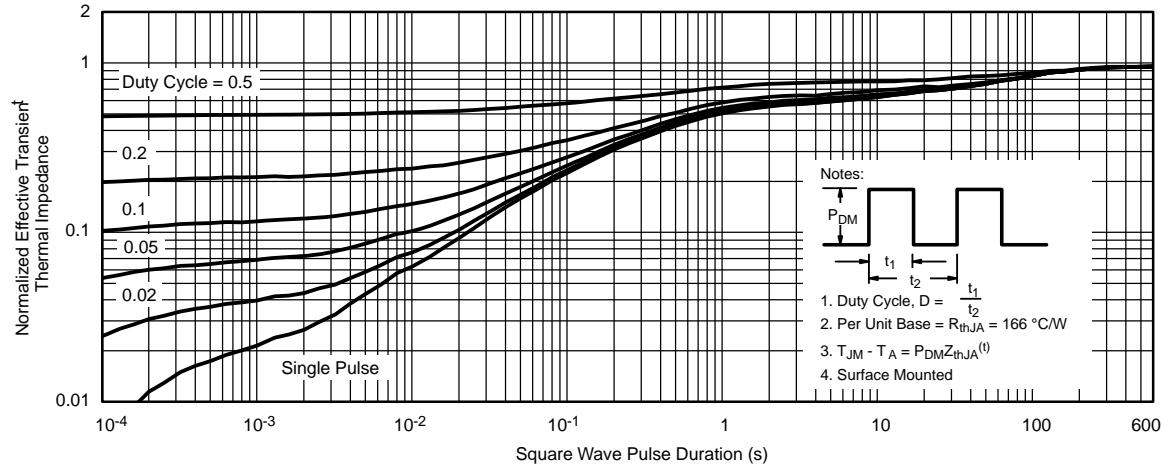


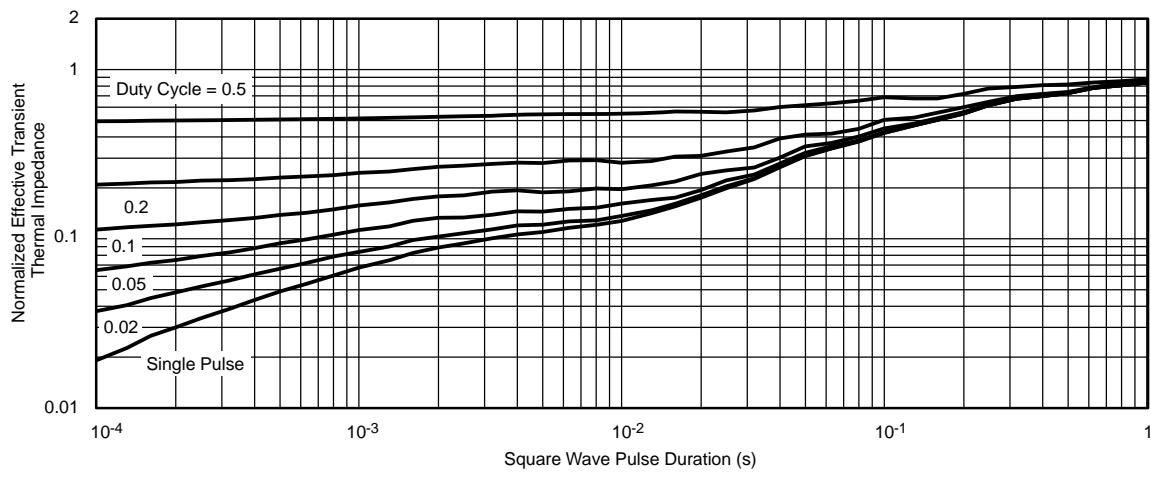
On-Resistance vs. Drain Current



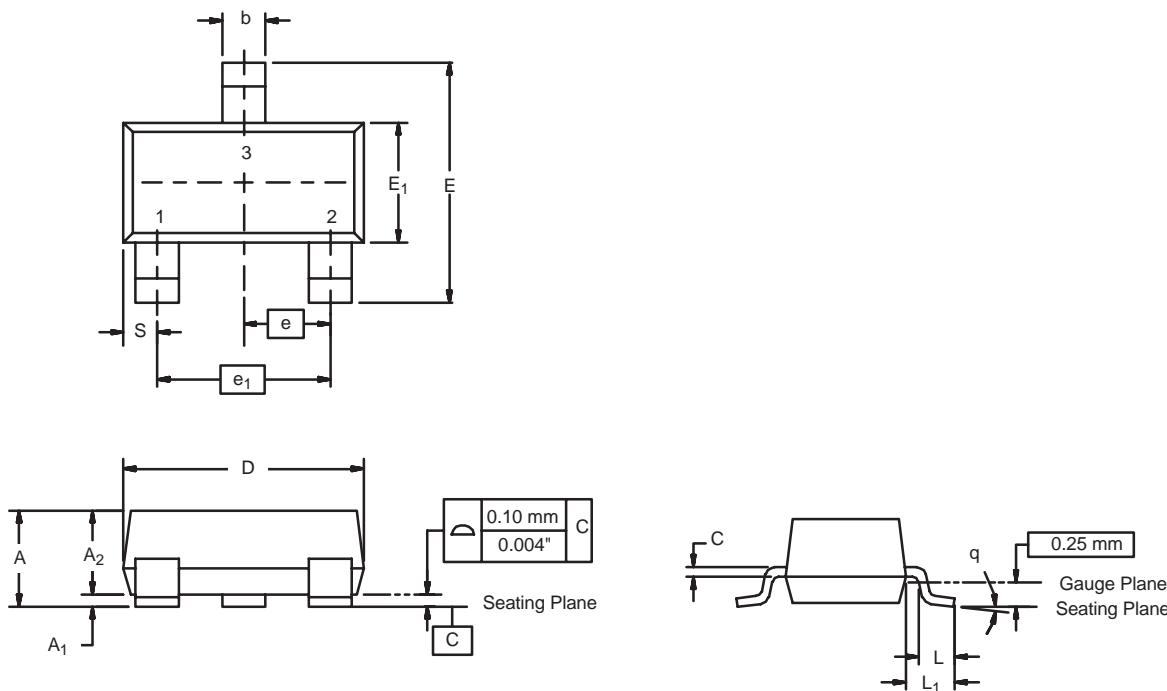
Capacitance

TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise noted)

THERMAL RATINGS ($T_A = 25^\circ\text{C}$, unless otherwise noted)
**Safe Operating Area****Normalized Thermal Transient Impedance, Junction-to-Ambient**

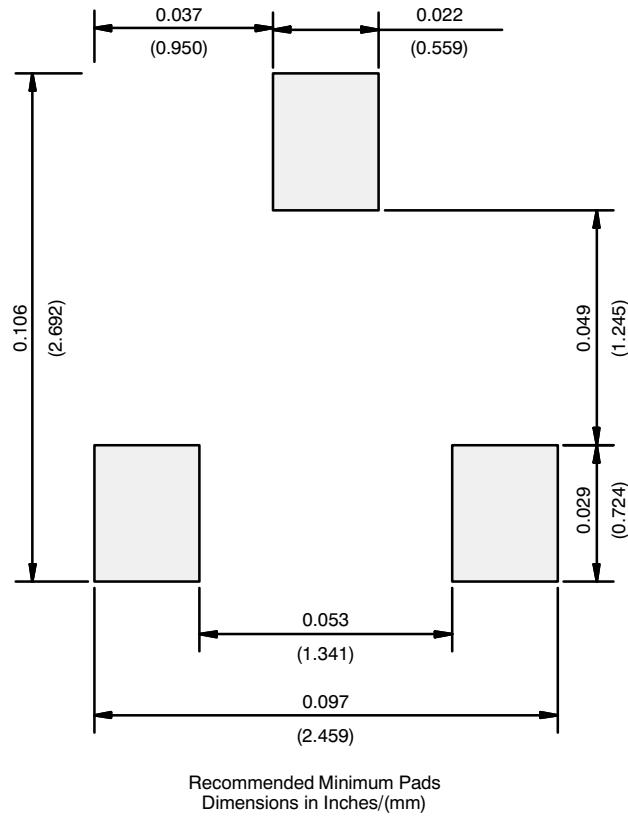
THERMAL RATINGS ($T_A = 25^\circ\text{C}$, unless otherwise noted)

Normalized Thermal Transient Impedance, Junction-to-Ambient
Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25°C)
 - Normalized Transient Thermal Impedance Junction-to-Foot (25°C)
- are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

SOT-23 (TO-236): 3-LEAD

Dim	MILLIMETERS		INCHES	
	Min	Max	Min	Max
A	0.89	1.12	0.035	0.044
A ₁	0.01	0.10	0.0004	0.004
A ₂	0.88	1.02	0.0346	0.040
b	0.35	0.50	0.014	0.020
c	0.085	0.18	0.003	0.007
D	2.80	3.04	0.110	0.120
E	2.10	2.64	0.083	0.104
E ₁	1.20	1.40	0.047	0.055
e	0.95 BSC		0.0374 Ref	
e ₁	1.90 BSC		0.0748 Ref	
L	0.40	0.60	0.016	0.024
L ₁	0.64 Ref		0.025 Ref	
S	0.50 Ref		0.020 Ref	
q	3°	8°	3°	8°

ECN: S-03946-Rev. K, 09-Jul-01
DWG: 5479

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